

## T496C106K025BT6310

T496 HRA, Tantalum, MnO<sub>2</sub> Tantalum, HRA, 10 uF, 10%, 25 VDC, SMD, MnO<sub>2</sub>, Molded, Military, Fused, High Reliability, B (0.1%/1000 Hrs), 600 mOhms, 6032, 2.8 mm, 1.3 mm



Click [here](#) for the 3D model.

### General Information

Series	T496 HRA
Dielectric	MnO <sub>2</sub> Tantalum
Style	SMD Chip
Description	SMD, MnO <sub>2</sub> , Molded, Military, Fused, High Reliability
Features	Internal Fuse, High Reliability
RoHS	Yes
Termination	Tin
AEC-Q200	No
Typical Component Weight	224.48 mg

### Specifications

Capacitance	10 uF
Tolerance	10%
Voltage DC	25 VDC (85C), 16.75 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	6% 120Hz 25C
Failure Rate	B (0.1%/1000 Hrs)
ESR	600 mOhms (100kHz 25C)
Ripple Current	428 mA (rms, 100kHz 25C)
Leakage Current	2.5 uA (5min 25°C)
Testing and Reliability	Surge Testing At -55C And +85C After Weibull

### Dimensions

L	6mm +/-0.3mm
W	3.2mm +/-0.3mm
H	2.5mm +/-0.3mm
T	0.13mm REF
S	1.3mm +/-0.3mm
F	2.2mm +/-0.1mm
A	3.1mm MIN
B	0.5mm +/-0.15mm
E	2.4mm REF
G	2.8mm REF
P	0.9mm REF
R	1mm REF
X	0.1mm +/-0.1mm REF

### Packaging Specifications

Packaging	T&R, 178mm
Packaging Quantity	500

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.